TOSHIBA Diode Silicon Epitaxial Planar Type

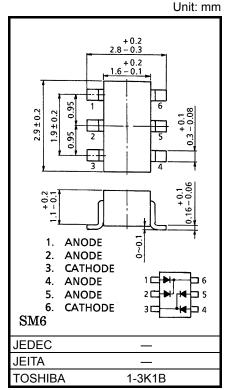
# HN1D02F

### **Ultra-High-Speed Switching Applications**

• The HN1D02F is composed of two (2) cathode common units.

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	$V_{RM}$	85	V	
Reverse voltage	V <sub>R</sub>	80	V	
Maximum (peak) forward current	I <sub>FM</sub>	300 (*)	mA	
Average forward current	Io	100 (*)	mA	
Surge current (10 ms)	I <sub>FSM</sub>	2 (*)	Α	
Power dissipation	Р	300	mW	
Junction temperature	Tj	125	°C	
Storage temperature	T <sub>stg</sub>	-55 to 125	°C	



Weight: 0.015 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

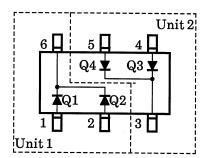
(\*) These are the Absolute Maximum Ratings for a single diode (Q1 or Q2 or Q3 or Q4). If Unit 1 and Unit 2 are used independently or simultaneously, the Absolute Maximum Ratings per diode are 75% of those of a single diode.

## Electrical Characteristics (Q1, Q2, Q3, Q4 Common, Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1 mA	1	0.60	_	٧	
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 10 mA	l	0.72	_		
	V <sub>F (3)</sub>	_	I <sub>F</sub> = 100 mA	1	0.90	1.20		
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30 V	ı	1	0.1		
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 80 V	1	-	0.5	μΑ	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0, f = 1 MHz		0.9	3.0	pF	
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> =10 mA (Fig. 1)		1.6	4.0	ns	

Start of commercial production 1992-05

## Pin Assignment (Top View)



### Marking

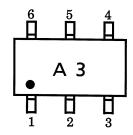
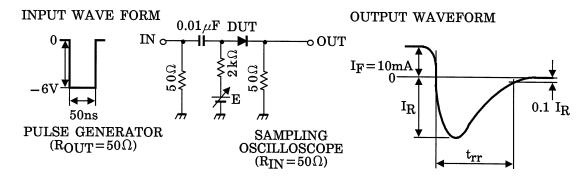
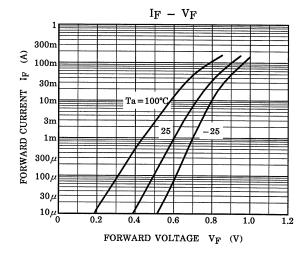
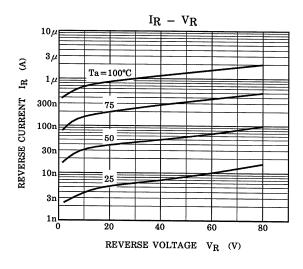


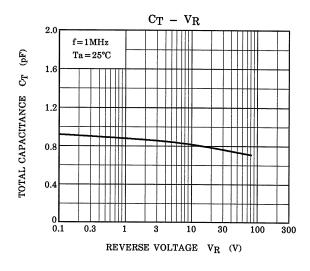
Fig. 1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit



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